



SPP6307

P-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPP6307 is the P-Channel enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where high-side switching , low in-line power loss, and resistance to transients are needed.

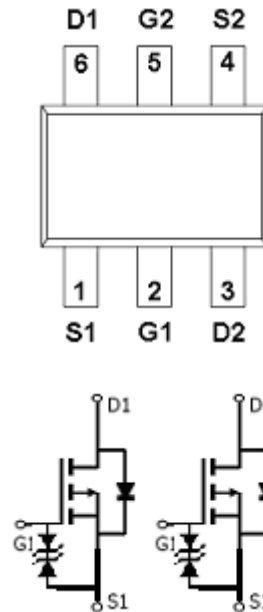
FEATURES

- ◆ P-Channel
 -20V/0.45A, $R_{DS(ON)} = 0.65\Omega @ V_{GS} = -4.5V$
 -20V/0.35A, $R_{DS(ON)} = 0.90\Omega @ V_{GS} = -2.5V$
 -20V/0.25A, $R_{DS(ON)} = 1.5\Omega @ V_{GS} = -1.8V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-363 package design

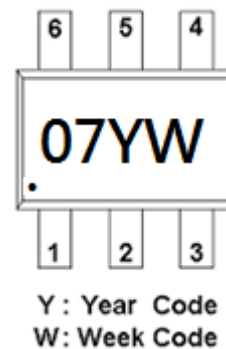
APPLICATIONS

- Drivers : Relays/Solenoids/Lamps/Hammers
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

PIN CONFIGURATION(SOT-363)



PART MARKING





SPP6307

P-Channel Enhancement Mode MOSFET

PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	D2	Drain 2
4	S2	Source 2
5	G2	Gate 2
6	D1	Drain1

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP6307S36RGB	SOT-363	07

※ SPP1073S72RGB : Tape Reel ; Pb – Free, Halogen – Fre

ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-30	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	I _D	TA=25°C	-0.45
		TA=80°C	-0.35
Pulsed Drain Current	I _{DM}	-1.0	A
Continuous Source Current(Diode Conduction)	I _S	-0.3	A
Power Dissipation	P _D	TA=25°C	0.27
		TA=70°C	0.16
Operating Junction Temperature	T _J	-55/150	°C
Storage Temperature Range	T _{STG}	-55/150	°C

ELECTRICAL CHARACTERISTICS



SPP6307

P-Channel Enhancement Mode MOSFET

(TA=25°C Unless otherwise noted)

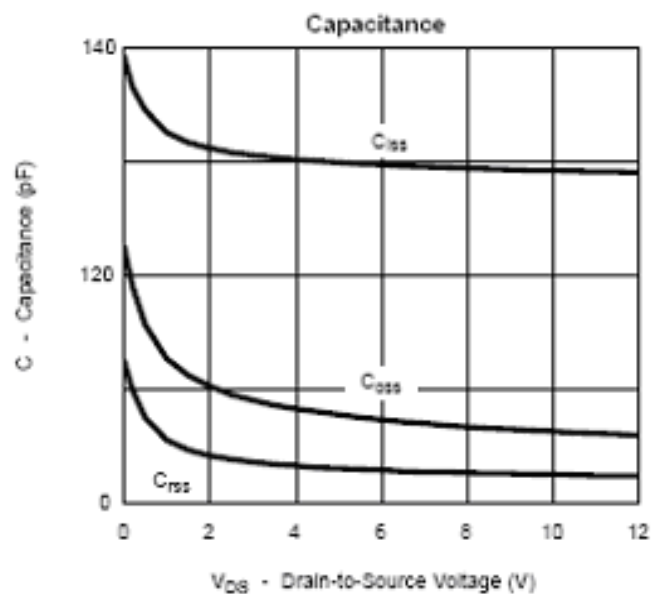
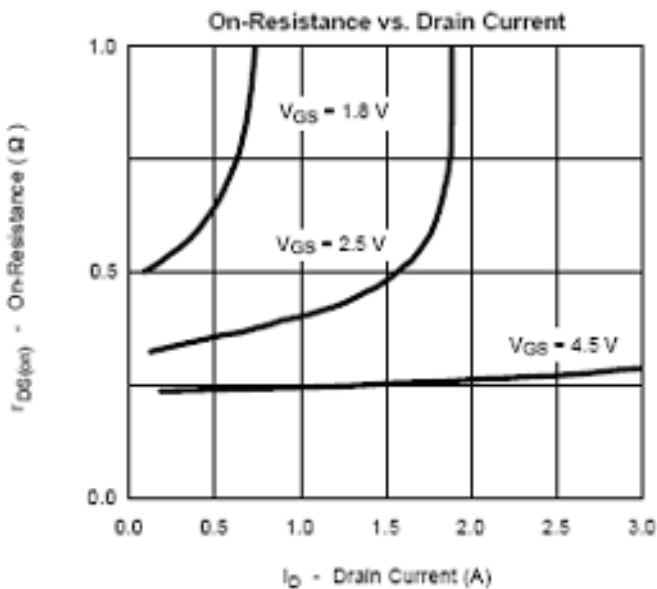
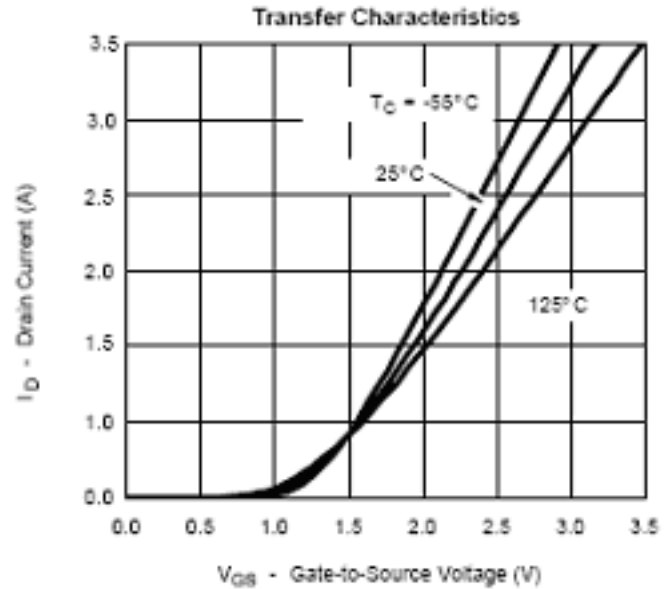
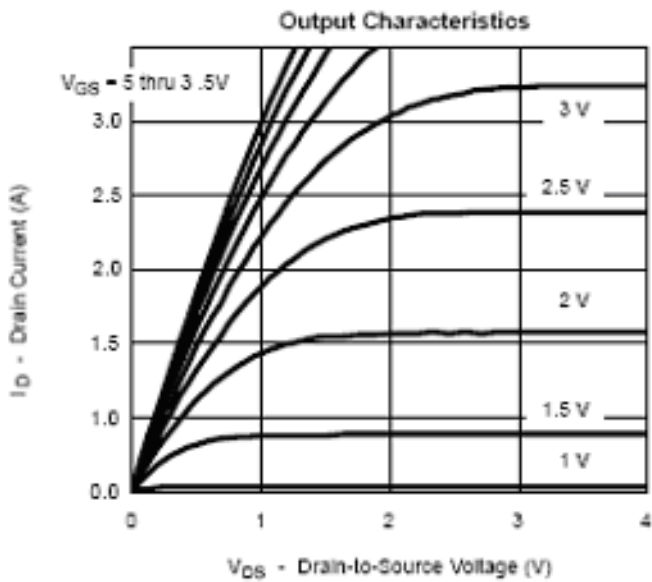
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.35		-1.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$			± 30	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V$			-1	μA
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=55^\circ C$			-5	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \leq -4.5V, V_{GS} = -5V$	-0.7			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-0.45A$			0.65	Ω
		$V_{GS}=-2.5V, I_D=-0.35A$			0.90	
		$V_{GS}=-1.8V, I_D=-0.25A$			1.50	
Forward Transconductance	g_{fs}	$V_{DS}=-10V, I_D=-0.25A$		0.4		S
Diode Forward Voltage	V_{SD}	$I_S=-0.15A, V_{GS}=0V$		-0.8	-1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=-10V, V_{GS}=-4.5V, I_D \equiv -0.6A$		1.5	2.0	nC
Gate-Source Charge	Q_{gs}			0.3		
Gate-Drain Charge	Q_{gd}			0.35		
Turn-On Time	$t_{d(on)}$	$V_{DD}=-10V, R_L=10\Omega, I_D \equiv -0.4A$ $V_{GEN}=-4.5V, R_G=6\Omega$		5	10	ns
	t_r			15	25	
Turn-Off Time	$t_{d(off)}$			8	15	
	t_f			1.4	1.8	

TYPICAL CHARACTERISTICS



SPP6307

P-Channel Enhancement Mode MOSFET

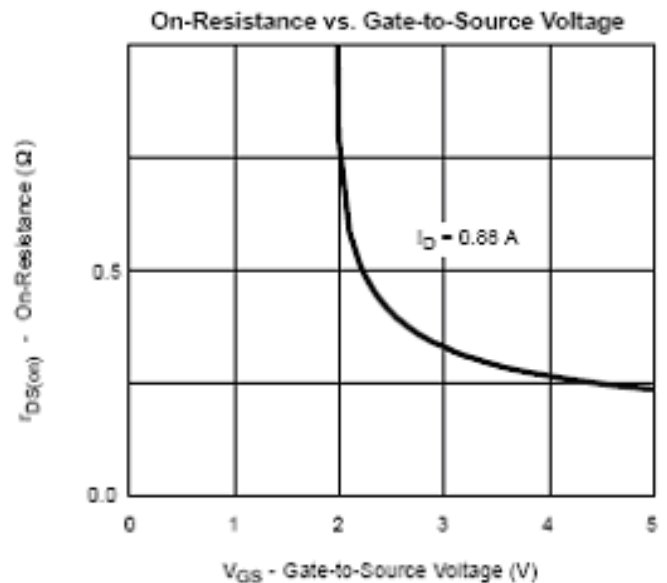
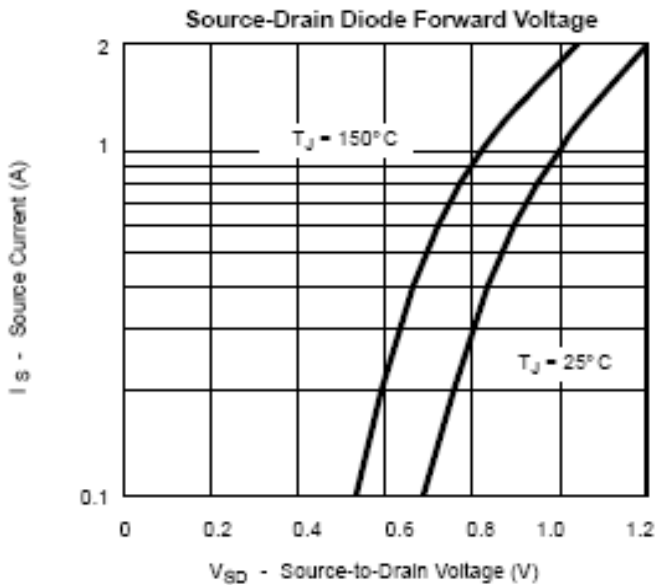
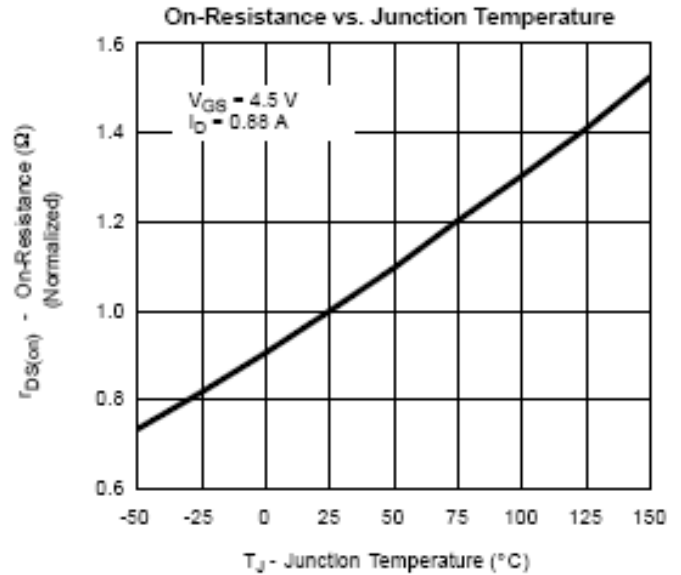
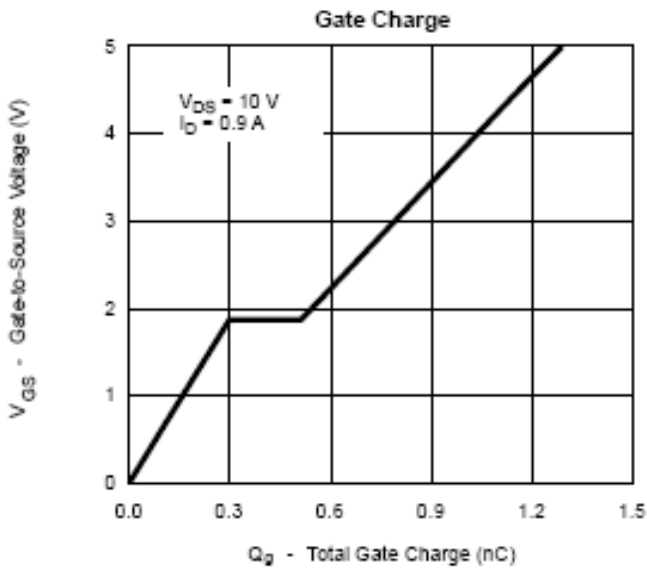


TYPICAL CHARACTERISTICS



SPP6307

P-Channel Enhancement Mode MOSFET

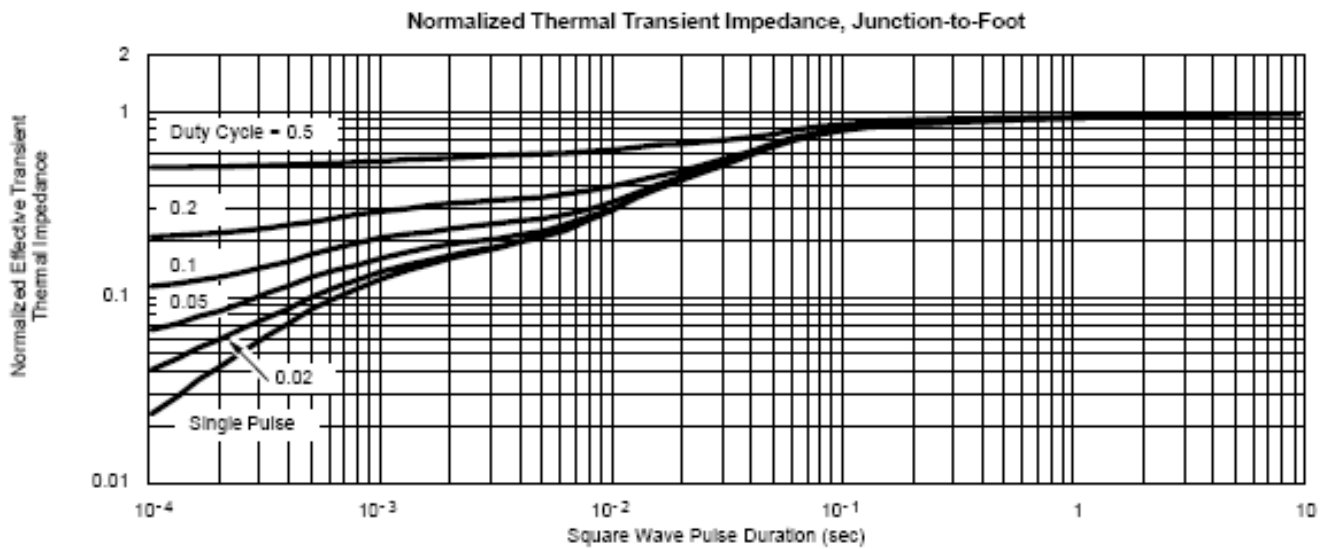
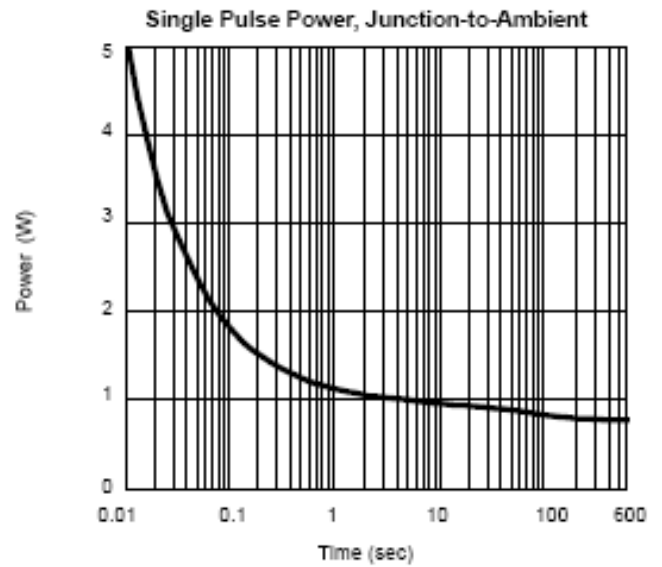
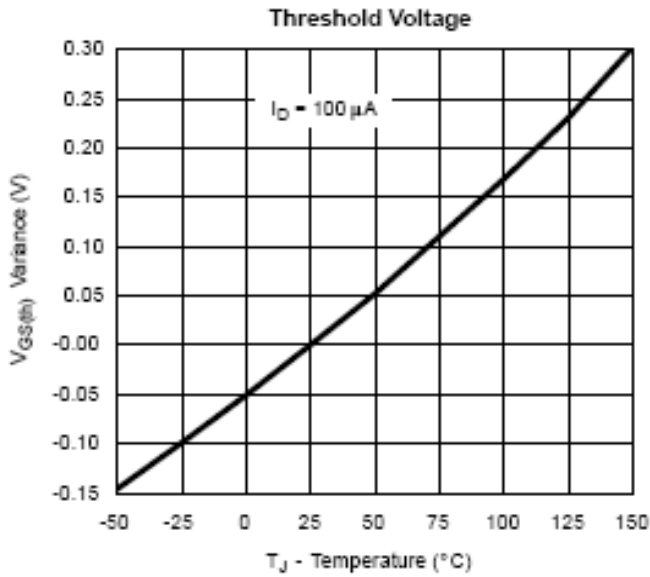


TYPICAL CHARACTERISTICS



SPP6307

P-Channel Enhancement Mode MOSFET

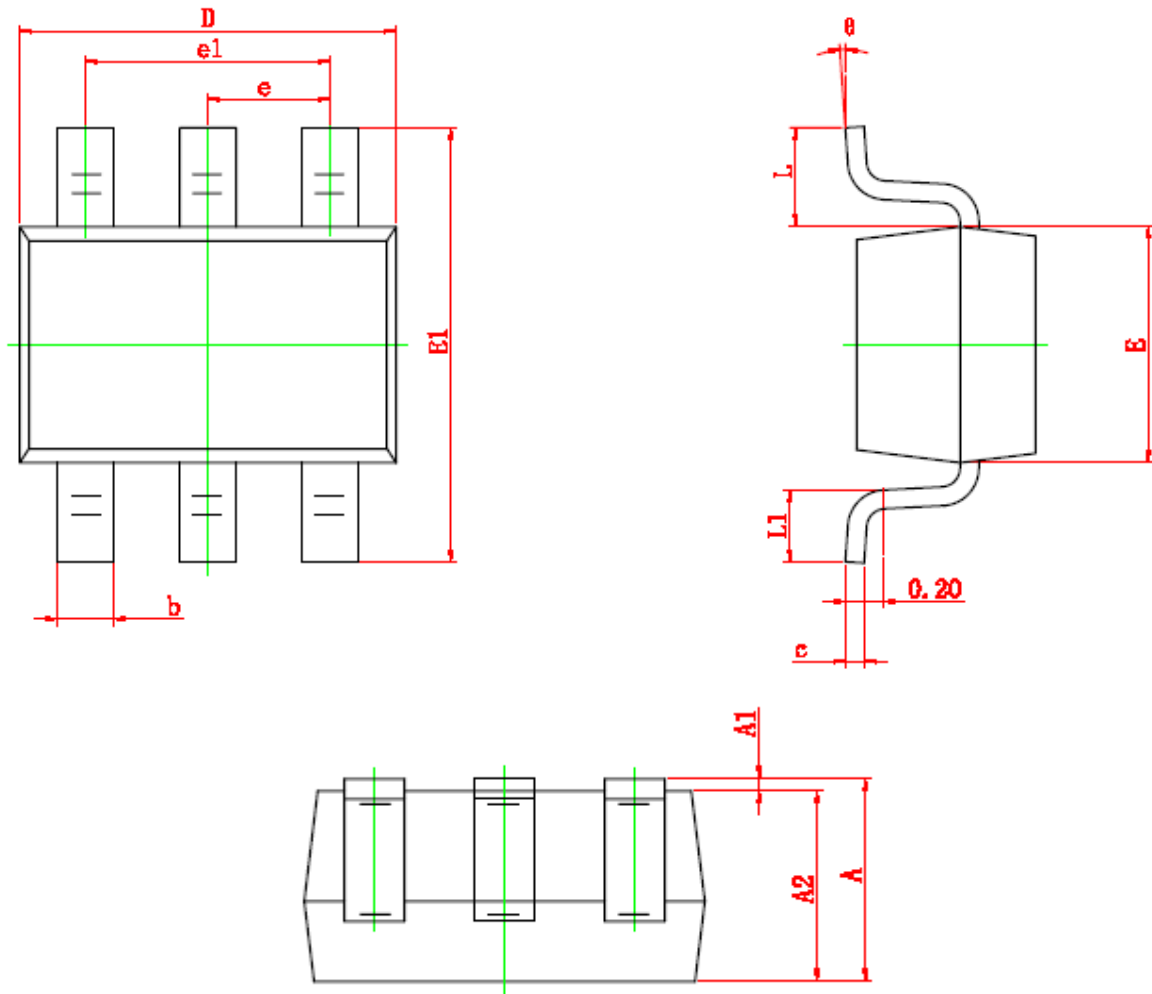


SOT-363 PACKAGE OUTLINE



SPP6307

P-Channel Enhancement Mode MOSFET



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°



SPP6307

P-Channel Enhancement Mode MOSFET

Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties which may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

©The SYNC Power logo is a registered trademark of SYNC Power Corporation
©2004 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved
SYNC Power Corporation
7F-2, No.3-1, Park Street
NanKang District (NKSP), Taipei, Taiwan 115
Phone: 886-2-2655-8178
Fax: 886-2-2655-8468
©<http://www.syncpower.com>